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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/811,207	03/26/2004	Cheisan J. Yue	P04,0097 (H0005049,SBE 16	1964
HONEYWELI	7590 07/09/200 .INTERNATIONAL.I	EXAMINER		
101 COLUMBIA ROAD			LEWIS, MONICA	
P O BOX 2245 MORRISTOW	N. NJ 07962-2245		ART UNIT	PAPER NUMBER
	- ,		2822	
			NOTIFICATION DATE	DELIVERY MODE
			07/09/2008	ELECTRONIC

## Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

DAVID.HOIRIIS@HONEYWELL.COM

# Application No. Applicant(s) YUE ET AL. 10/811,207 Office Action Summary Examiner Art Unit

	· · · · · · · · · · · · · · · · · · ·	Examiner	ALC OTHE	i			
		Monica Lewis	2822				
	The MAILING DATE of this communication app	ears on the cover sheet with the c	orrespondence ac	ldress			
Period fo	• •						
WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPL.  LEVER IS LONGER, FROM THE MALING D/  nations of time map he available under the provision of 37 CPR 11.  SN(6) MONTHS from the mitting idea of the communication.  D period for reply is specified above, the maximum statutory period used to the communication.  The reply received by the Office later than three months after the mailing and patient term adjustment. See 37 CFR 1.704(p).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	N. nely filed the mailing date of this o D (35 U.S.C. § 133).	,			
Status							
1) 又	Responsive to communication(s) filed on 17 M	arch 2008					
		action is non-final.					
	Since this application is in condition for allowar		secution as to the	e merits is			
	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposit	ion of Claims						
•	☑ Claim(s) <u>1-19</u> is/are pending in the application.						
	4a) Of the above claim(s) is/are withdrawn from consideration.						
	Claim(s) is/are allowed.						
6)🖂	Claim(s) 1-19 is/are rejected.						
7)	Claim(s) is/are objected to.						
8)□	Claim(s) are subject to restriction and/or	r election requirement.					
Applicat	ion Papers						
9)	The specification is objected to by the Examine	r.					
10)🛛	10) ☐ The drawing(s) filed on 26 March 2004 is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
	Replacement drawing sheet(s) including the correct	ion is required if the drawing(s) is obj	ected to. See 37 C	FR 1.121(d).			
11)	The oath or declaration is objected to by the Ex	aminer. Note the attached Office	Action or form P	ΓO-152.			
Priority (	under 35 U.S.C. § 119						
	Acknowledgment is made of a claim for foreign  ☐ All b)☐ Some * c)☐ None of:	priority under 35 U.S.C. § 119(a)	+(d) or (f).				
	<ol> <li>Certified copies of the priority documents</li> </ol>	s have been received.					
	2. Certified copies of the priority documents						
	3. Copies of the certified copies of the prior	-	ed in this National	Stage			
	application from the International Bureau						
	See the attached detailed Office action for a list	or the certified copies not receive	u.				
Attachmen	nt(s)						
		,	(DTO 440)				

1) Notice of References Cited (PTO-892)
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
3) Information Disclosure Statement(s) (PTC/SD/08) Interview Summary (PTO-413)
 Paper No(s)/Mail Date. \_\_\_\_\_. 5) Notice of Informal Patent Application.
6) Other: Paper No(s)/Mail Date \_\_ U.S. Patent and Trademark Office PTOL-326 (Rev. 08-06) Office Action Summary Part of Paper No./Mail Date 20080701 Application/Control Number: 10/811,207 Page 2

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#### DETAILED ACTION

1. This office action is in response to the pre-appeal filed March 17, 2008.

#### Response to Arguments

 Applicant's arguments with respect to claims 1-19 have been considered but are moot in view of the new ground(s) of rejection.

## Claim Rejections - 35 USC § 103

- The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all
  obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- Claims 1, 2, 5, 6, 9, 10, 13, 14 and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over Librizzi et al. (U.S. Patent No. 6,429,502) in view of Ajmera et al. (U.S. Patent No. 6,521,947).

In regards to claim 1, Librizzi et al. ("Librizzi") discloses the following:

- a) a semiconductor substrate (40) (For Example: See Figure 2);
- b) a buried insulation layer (42) over the semiconductor substrate (For Example: See Figure 2);
- c) a semiconductor mesa (28 or 34) over the buried insulation layer (For Example: See Figure 1 and Figure 2); and
- d) a guard ring (36 and 38) substantially surrounding the semiconductor mesa, and wherein the guard ring is arranged to provide RF isolation for the semiconductor mesa (For Example: See Figure 1 and Column 5 Lines 55-57).

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In regards to claim 1, Librizzi fails to disclose the following:

a) the guard ring extends through the buried insulation layer contacting the semiconductor substrate.

However, Ajmera et al. ("Ajmera") discloses a semiconductor device that has a guard ring (20) that extends through the buried insulation layer contacting the semiconductor substrate (For Example: See Figure 11 and Figure 12). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Librizzi to include a guard ring that extends through the buried insulation layer contacting the semiconductor substrate as disclosed in Ajmera because it aids in preventing diffusion of dopants (For Example: See Column 3 Lines 60-65).

Additionally, since Librizzi and Ajmera are both from the same field of endeavor, the purpose disclosed by Ajmera would have been recognized in the pertinent art of Librizzi.

In regards to claims 2, 6, 10 and 14, Librizzi discloses the following:

a) the semiconductor substrate comprises a high resistivity semiconductor substrate (For Example: See Column 5 Lines 19-22).

In regards to claims 5 and 13, Librizzi discloses the following:

a) the semiconductor substrate is doped in an area that is contacted by the guard ring (For Example: See Column 5 Lines 15 and 16).

In regards to claim 9, Librizzi discloses the following:

a) an insulating ring (26) between the guard ring and the semiconductor mesa, wherein the insulating ring surrounds the semiconductor mesa (For Example: See Figure 1).

In regards to claim 17, Librizzi discloses the following:

a) the guard ring comprises a low resistivity guard ring (For Example: See Column 6 Line 6).

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 Claims 3, 4, 7, 8, 11, 12, 15 and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Librizzi et al. (U.S. Patent No. 6,429,502) in view of Ajmera et al. (U.S. Patent No. 6,521,947) and Beyer et al. (U.S. Patent No. 5,264,387).

In regards to claims 3, 7, 11 and 15, Librizzi discloses the following:

 a) the semiconductor substrate comprises a silicon substrate, wherein the buried insulating layer comprises a buried silicon oxide layer (For Example: See Column 5 Lines 14-18).

In regards to claims 3, 7, 11 and 15, Librizzi fails to disclose the following:

a) the semiconductor mesa comprises a silicon mesa.

However, Beyer et al. ("Beyer") discloses a semiconductor device that has semiconductor mesa that comprises a silicon mesa (For Example: See Column 3 Lines 15 and 16). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Librizzi to include semiconductor mesa that comprises a silicon mesa as disclosed in Beyer because it aids in providing low leakage (For Example: See Column 2 Lines 20-24).

Additionally, since Librizzi and Beyer are both from the same field of endeavor, the purpose disclosed by Beyer would have been recognized in the pertinent art of Librizzi.

In regards to claims 4, 8, 12 and 16, Librizzi discloses the following:

a) the semiconductor substrate comprises a high resistivity semiconductor substrate (For Example: See Column 5 Lines 19-22).

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Claims 18 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Librizzi
et al. (U.S. Patent No. 6,429,502) in view of Ajmera et al. (U.S. Patent No. 6,521,947) and
Hirabayashi (U.S. Patent No. 5,889,314).

In regards to claim 18, Librizzi fails to disclose the following:

a) the guard ring comprises a metal guard ring.

However, Hirabayashi discloses a semiconductor device that has a metal guard ring (For Example: See Column 5 Lines 1-14). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Librizzi to include a metal guard ring as disclosed in Hirabayashi because it aids in providing a low resistance (For Example: See Column 5 Lines 1-14).

Additionally, since Librizzi and Hirabayashi are both from the same field of endeavor, the purpose disclosed by Hirabayashi would have been recognized in the pertinent art of Librizzi.

In regards to claim 19, Librizzi fails to disclose the following:

a) the guard ring comprises a tungsten guard ring.

However, Hirabayashi discloses a semiconductor device that has a tungsten guard ring (For Example: See Column 5 Lines 1-14). It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the semiconductor of Librizzi to include a tungsten guard ring as disclosed in Hirabayashi because it aids in providing a low resistance (For Example: See Column 5 Lines 1-14).

Additionally, since Librizzi and Hirabayashi are both from the same field of endeavor, the purpose disclosed by Hirabayashi would have been recognized in the pertinent art of Librizzi. Application/Control Number: 10/811,207 Page 6

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### Conclusion

7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Monica Lewis whose telephone number is 571-272-1838.
If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Zandra Smith can be reached on 571-272-2429. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300 for regular and after final communications.

/Monica Lewis/ Primary Examiner, Art Unit 2822 July 1, 2008